

# QUICKSWITCH® PRODUCTS 3.3V 32-BIT BUS SWITCH FOR HOT SWAP APPLICATIONS (HOTSWITCHTM)

#### IDTQS34XVH245

# **FEATURES:**

- N channel FET switches with no parasitic diode to Vcc
  - No DC path to Vcc or GND
  - 5V tolerant in OFF and ON state
- 5V tolerant I/Os
- · Low Ron, 4Ω typical
- Flat Ron characteristics from 0 5V
- Rail-to-rail switching 0 5V
- Bidirectional dataflow with near-zero delay: no added ground bounce
- · Excellent Ron matching between channels
- · Vcc operation: 2.3V to 3.6V
- High bandwidth up to 500MHz
- LVTTL-compatible control Inputs
- · Undershoot Clamp Diodes on all switch and control Inputs
- · Low I/O capacitance, 5pF typical
- · Available in 80-pin QVSOP package

## **APPLICATIONS:**

- · PCI/Compact PCI hot-swapping
- · 10/100 Base-T, Ethernet LAN switch
- · Low distortion analog switch
- · Replaces mechanical relays
- ATM 25/155 switching

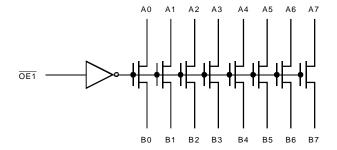
## **DESCRIPTION:**

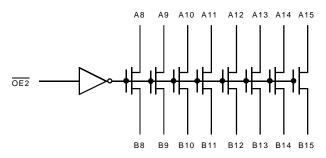
The QS34XVH245 HotSwitch 32-bit bus switch is specially designed for a hot-swapping environment. The QS34XVH245 has very low ON resistance, resulting in under 250ps propagation delay through the switch. The switches can be turned ON under the control of individual LVTTL-compatible Output Enable  $(\overline{\text{OEx}})$  signals for bidirectional data flow with no added delay or ground bounce. In the OFF and ON states, the switches are 5V-tolerant. In the OFF state, the switches offer very high impedence at the terminals.

The combination of near-zero propagation delay, high OFF impedance, and over-voltage tolerance makes the QS34XVH245 ideal for hot-swapping applications. The low ON resistance of the QS34XVH245 makes it ideal for PCI and Compact PCI hot-swapping environments.

The QS34XVH245 is characterized for operation from -40°C to +85°C.

## **FUNCTIONAL BLOCK DIAGRAM**



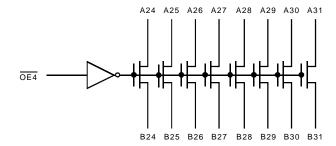


OE3

A16 A17 A18 A19 A20 A21 A22 A23

OE3

R16 B17 B18 B19 B20 B21 B22 B23

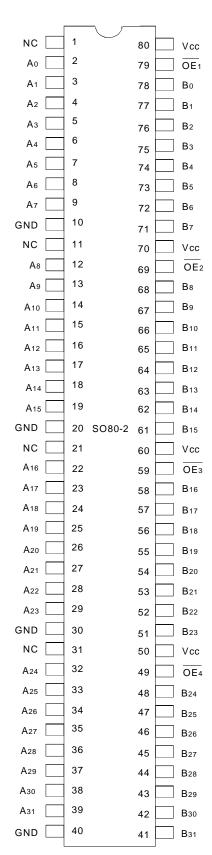


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**INDUSTRIAL TEMPERATURE RANGE** 

**NOVEMBER 2001** 

# **PIN CONFIGURATION**



QVSOP TOP VIEW

# **ABSOLUTE MAXIMUM RATINGS**(1)

Symbol	Description	Max	Unit
VTERM <sup>(2)</sup>	Supply Voltage to Ground	-0.5 to +4.6	V
VTERM <sup>(3)</sup>	DC Switch Voltage Vs	-0.5 to +5.5	V
VTERM <sup>(3)</sup>	DC Input Voltage ViN	-0.5 to +5.5	V
VAC	AC Input Voltage (pulse width ≤20ns)	-3	٧
<b>V</b> out	DC Output Current	120	mA
Рмах	Maximum Power Dissipation	0.92	W
Tstg	Storage Temperature	-65 to +150	°C

#### NOTES:

- 1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- 2. Vcc terminals.
- 3. All terminals except Vcc .

## **CAPACITANCE** (TA = +25°C, F = 1MHz, Vin = 0V, Vout = 0V)

Symbol	Parameter <sup>(1)</sup>	Тур.	Max.	Unit
CIN	Control Inputs	3	5	pF
Cı/o	Quickswitch Channels (Switch OFF)	5	6	pF

#### NOTE:

1. This parameter is guaranteed but not production tested.

## **PIN DESCRIPTION**

Pin Names	I/O	Description		
ŌĒx	I	Output Enable		
Ax	I/O	Bus A		
Вх	I/O	Bus B		

## **FUNCTION TABLE**(1)

<del></del> <del>OEx</del>	Function
Н	Disconnect
L	Connect

#### NOTE

1. H = HIGH Voltage Level

L = LOW Voltage Level

# DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

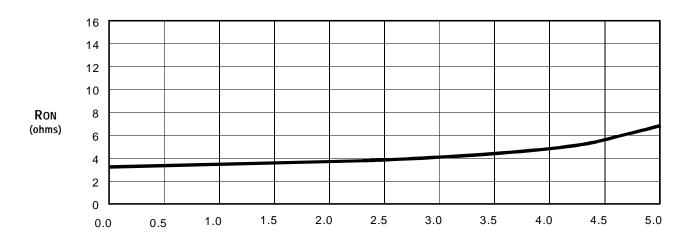
 $Following \, Conditions \, Apply \, Unless \, Otherwise \, Specified: \,$ 

Industrial: TA = -40°C to +85°C, VCC =  $3.3V \pm 0.3V$ 

Symbol	Parameter	Test Conditions	Min.	Typ. <sup>(1)</sup>	Мах.	Unit
ViH	Input HIGH Voltage	Guaranteed Logic HIGH for Control Inputs	2	_	_	V
VIL	Input LOW Voltage	Guaranteed Logic LOW for Control Inputs	_	_	0.8	V
lin	Input Leakage Current (Control Inputs)	$0V \le \overline{OE} \le Vcc$		_	±1	μA
loz	Off-State Current (Hi-Z)	0V ≤ A, B ≤ Vcc, Switches OFF	_	_	±1	μA
Ron	Switch ON Resistance	Vcc = Min, Vin = 0V, Ion = 30mA		4	6	Ω
		VCC = Min, VIN = 2.4V, ION = 15mA	_	5	8	•

#### NOTE:

# TYPICAL ON RESISTANCE vs Vin AT Vcc = 3.3V



VIN (Volts)

<sup>1.</sup> Typical values are at Vcc = 3.3V and TA = 25°C.

## **POWER SUPPLY CHARACTERISTICS**

Symbol	Parameter	Test Conditions <sup>(1)</sup>	Max.	Unit
Icco	Quiescent Power Supply Current	Vcc = Max., Vin = GND or Vcc, f = 0	12	mA
Δlcc	Power Supply Current (2,3) per Input HIGH	Vcc = 3.6V, Vin = 3V, f = 0 per Control Input	30	μA
ICCD	Dynamic Power Supply Current per MHz <sup>(4)</sup>	Vcc = 3.6V, A and B Pins Open, per Control Input Toggling @ 50% Duty Cycle	0.25	mA/MHz

#### NOTES:

- 1. For conditions shown as Min. or Max., use the appropriate values specified under DC Electrical Characteristics.
- 2. Per LVTTL-driven-control-input. A and B pins do not contribute to  $\Delta lcc.$
- 3. This parameter is guaranteed but not tested.
- 4. This parameter represents the current required to switch internal capacitance at the specified frequency. The A and B inputs do not contribute to the Dynamic Power Supply Current. This parameter is guaranteed but not production tested.

#### SWITCHING CHARACTERISTICS OVER OPERATING RANGE

 $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ ,  $V_{CC} = 3.3V \pm 0.3V$ 

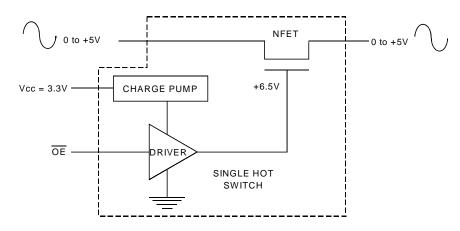
CLOAD = 50pF, RLOAD =  $500\Omega$ , unless otherwise noted

Symbol	Parameter	Min. <sup>(3)</sup>	Тур.	Max.	Unit
<b>t</b> PLH	Data Propagation Delay <sup>(1,2)</sup>	_	_	0.25	ns
<b>t</b> PHL	Ax to/from Bx				
<b>t</b> PZL	Switch Turn-On Delay	1.5	_	9	ns
tpzh	OEx to Ax/Bx				
tplz	Switch Turn-Off Delay <sup>(1)</sup>	1.5	_	8	ns
tphz	OEx to Ax/Bx				
<u>fOEx</u>	Operating Frequency - Enable <sup>(1,4)</sup>	_	_	1	MHz

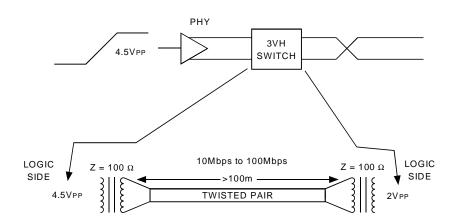
#### NOTES:

- 1. This parameter is guaranteed but not production tested.
- 2. The bus switch contributes no propagation delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25ns at C<sub>L</sub> = 50pF. Since this time constant is much smaller than the rise and fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay of the bus switch, when used in a system, is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.
- 3. Minimums are guaranteed but not production tested.
- 4. Maximum toggle frequency for OEx control input.

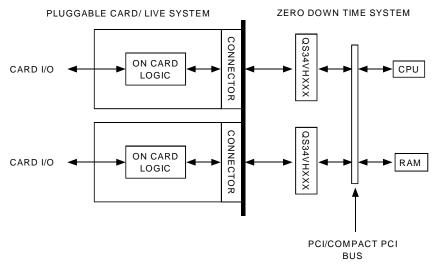
# SOME APPLICATIONS FOR HOTSWITCH PRODUCTS



Rail-to-Rail Switching

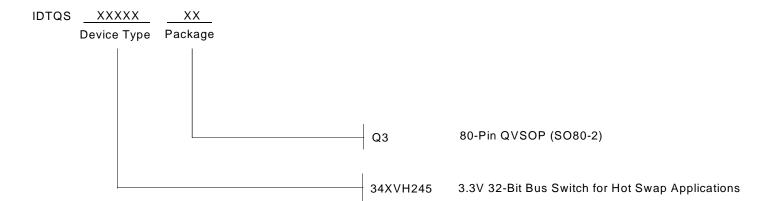


Fast Ethernet Data Switching (LAN Switch)



Hot-Swapping: PCI / Compact PCI

## **ORDERING INFORMATION**





CORPORATE HEADQUARTERS

2975 Stender Way Santa Clara, CA 95054 for SALES:

800-345-7015 or 408-727-6116 fax: 408-492-8674 www.idt.com

for Tech Support: logichelp@idt.com (408) 654-6459